



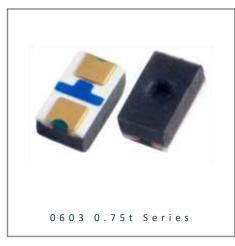
## **PRODUCT DATASHEET**



- ► PCB / CHIP LED
- ▶ 0603 (1608) 0.75t
- Sky White

# NOW14S85ZBF-5MA





## **APPLICATIONS:**

- Keyboard Backlight
- Backlighting
- Indication Light
- Switch light
- Dashboard

# 0603 0.75t Series



## **FEATURES:**

- Package: PCB / CHIP LED Top View
- Forward Current: 5mA
- Forward Voltage (typ.): 3.0V
- Luminous Intensity (typ.): 13mcd@5mA
- Colour: Sky White
- Colour Temperature (CCT): 8300~86500K
- Viewing angle: 50°
- Materials:
  - Die: InGaN
  - Resin: Epoxy (Black Housing)
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
  - Forward voltage
  - Luminous intensity
  - Dominant wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with max.4000/reel, ø180mm (7")

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## CHARACTERISTICS:

#### Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	20	mA
Peak Forward Current Duty 1/10; width 0.1ms	IFP	80	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	IR	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatic Discharge (HBM)	ESD	6000	V
Operating Temperature	T <sub>OPR</sub>	-40~+80	°C
Storage Temperature	Tstg	-40~+100	°C

#### Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition	
Forward Voltage	V <sub>F</sub>	2.5	3.0	3.3	V	I <sub>F</sub> =5mA	
Luminous Intensity	lv		13		mcd	I⊧=5mA	
Chromaticity	х		0.2700			I⊧=5mA	
Coordinates	Y		0.2620				
Colour Temperature	ССТ		14000		к	I <sub>F</sub> =20mA	
Viewing Angle	<b>20</b> <sub>1/2</sub>		50		deg	I⊧=5mA	

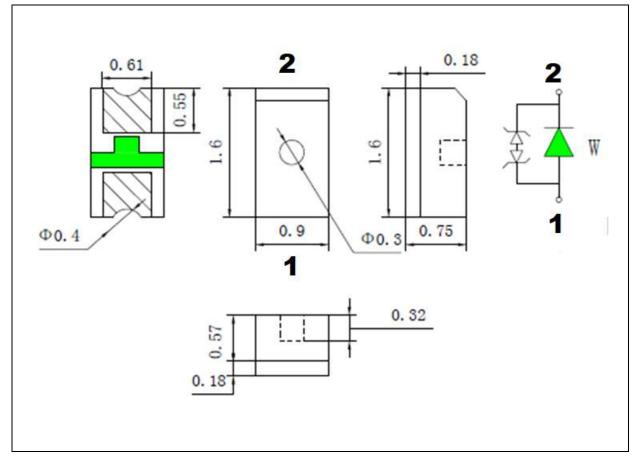
 $1. \qquad \text{Luminous intensity (I_{V}) \pm 10\%, Forward Voltage (V_{F}) \pm 0.1V, View Angle (2\theta_{1/2}) \pm 5\%, Dominant Wavelength (\lambda_{D}) \pm 1nm.}$ 

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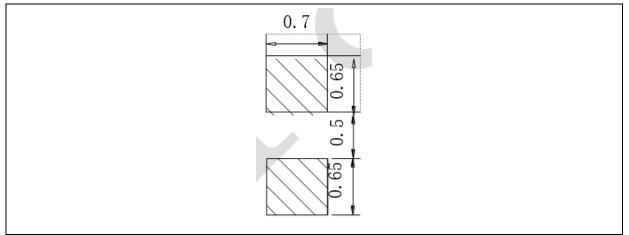
## **OUTLINE DIMENSION:**

#### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



### **BINNING GROUPS:**

Code	Min.	Max.	Unit
A	2.5	2.7	
В	2.7	2.9	V
С	2.9	3.1	V
C	3.1	3.3	

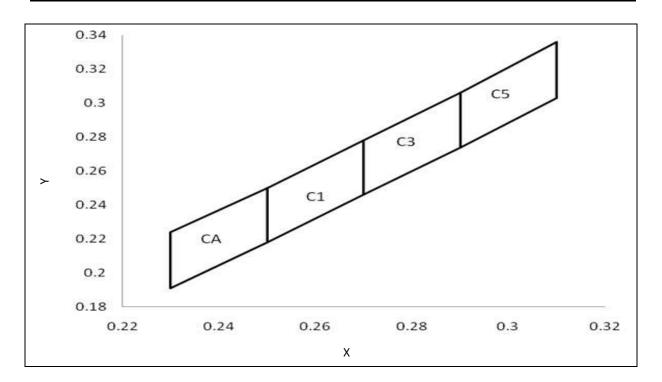
#### Forward Voltage Classifications ( $I_F = 5mA$ ):

#### Luminous Intensity Classifications (I<sub>F</sub> = 5mA):

Code	Min.	Max.	Unit
8	5	8	
9	8	12.5	
A	12.5	16	mcd
В	16	20	
С	20	25	



## **CIE CHROMATICITY DIAGRAM:**

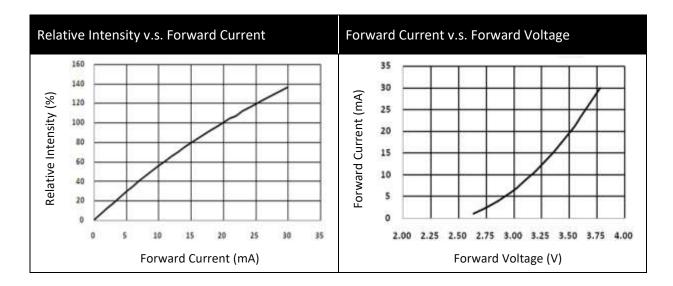


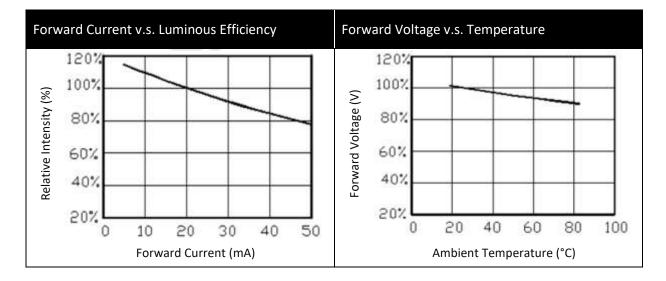
### Chromaticity Coordinates Classifications (I<sub>F</sub> = 5mA):

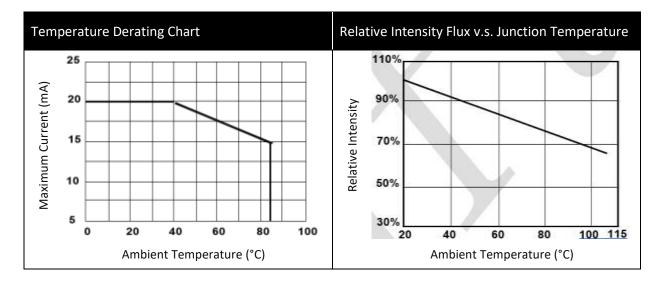
	1	L	2		3		4	
	Х	Y	х	Y	х	Y	Х	Y
CA	0.2500	0.2500	0.2300	0.2240	0.2300	0.1910	0.2500	0.2180
C1	0.2700	0.2780	0.2500	0.2500	0.2500	0.2180	0.2700	0.2460
C3	0.2900	0.3060	0.2700	0.2780	0.2700	0.2460	0.2900	0.2740
C5	0.3100	0.3360	0.2900	0.3060	0.2900	0.2740	0.3100	0.3030



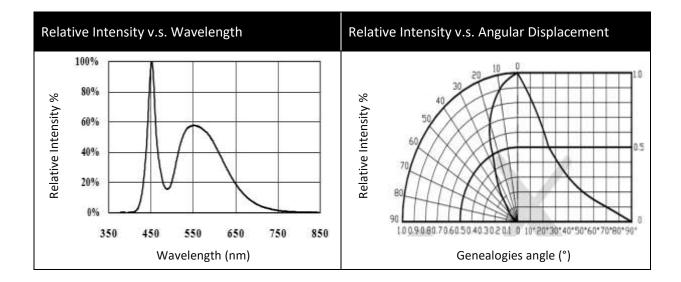
## **ELECTRO-OPTICAL CHARACTERISTICS:**





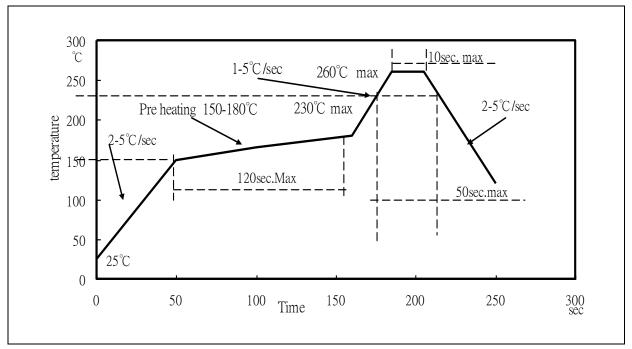








## **RECOMMENDED SOLDERING PROFILE:**



#### Reflow solder:

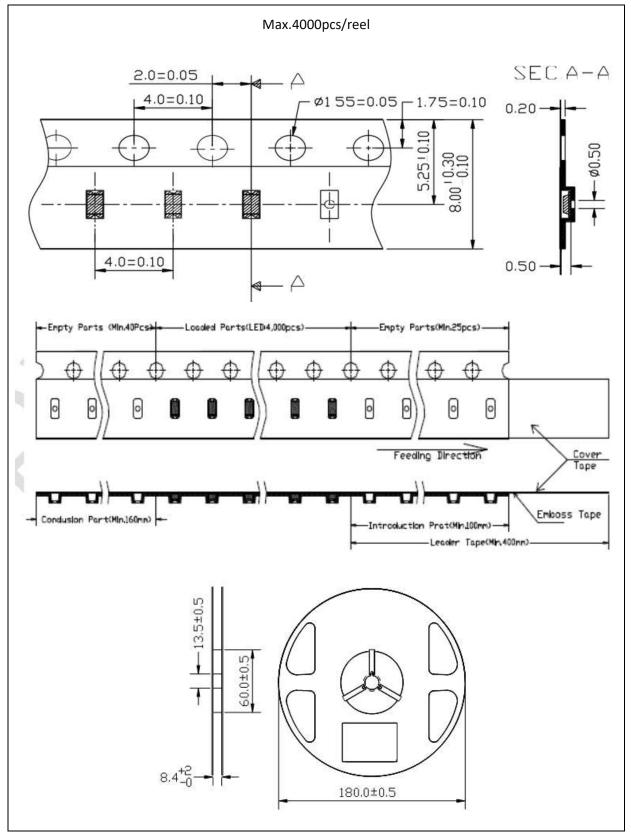
Note:

- 1. Recommend reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 3 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



### **PACKING SPECIFICATION:**

#### **Reel Dimension:**



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### **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

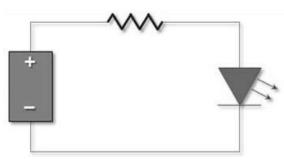
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



## **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	27/07/2016	Datasheet set-up.
A1.1	26/05/2022	New datasheet format.